

主要参数 MAIN CHARACTERISTICS

ID	110 A
VDSS	55 V
Rdson-typ (@Vgs=10V)	7.6 mΩ
Qg-typ	67 nC

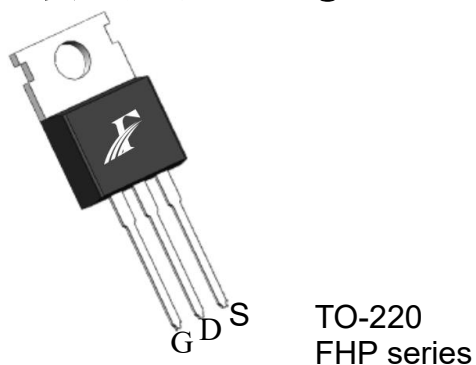
用途 APPLICATIONS

开关电源	Switch Mode Power Supply
12V逆变电源	Power management for 12V inverter systems
同步整流	Synchronous Rectification

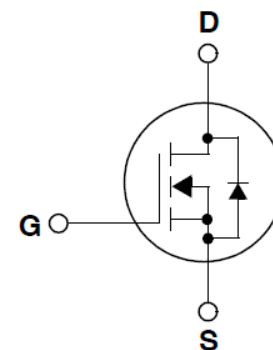
产品特性 FEATURES

低栅极电荷	Low gate charge
低 Crss (典型值 168 pF)	Low Crss (typical 168 pF)
开关速度快	Fast switching
100%经过 Rg 测试	100% Rg tested
100%经过雪崩测试	100% avalanche tested
100%经过热阻测试	100% DVDS tested
高抗 dv/dt 能力	Improved dv/dt capability
工艺	Plane technology
RoHS 产品	RoHS product

封装形式 Package



等效电路 Equivalent Circuit



绝对最大额定值 ABSOLUTE RATINGS (Tc=25°C)

项目 Parameter	符号 Symbol	数值 Value	单位 Unit
		FHP3205D	
最高漏极-源极直流电压 Drain-Source Voltage	V _{DS}	55	V
连续漏极电流* Drain Current -continuous *	I _D (T _C =25°C)	110	A
	I _D (T _C =100°C)	69.6	A
最大脉冲漏极电流 (注 1) Drain Current – pulse (note 1)	I _{DM}	440	A
最高栅源电压 Gate-Source Voltage	V _{GS}	±20	V
单脉冲雪崩能量 (注 2) Single Pulsed Avalanche Energy (note 2)	E _{AS}	312.5	mJ
雪崩电流 (注 1) Avalanche Current (note 1)	I _{AR}	25	A
重复雪崩能量 (注 1) Repetitive Avalanche Current (note 1)	E _{AR}	18	mJ
二极管反向恢复最大电压变化速率 (注 3) Peak Diode Recovery dv/dt (note 3)	dv/dt	5.0	V/ns
耗散功率 Power Dissipation	P _D (T _C =25°C)	200	W
	-Derate above 25°C	1.6	W/°C
最高结温及存储温度 Operating and Storage Temperature Range	T _J , T _{STG}	150, -55~+150	°C
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T _L	300	°C

*漏极电流由最高结温限制

*Drain current limited by maximum junction temperature

电特性 ELECTRICAL CHARACTERISTICS

项目 Parameter	符号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
关态特性 Off –Characteristics						
漏－源击穿电压 Drain-Source Voltage	BV _{DSS}	I _D =250μA, V _{GS} =0V	55	-	-	V
击穿电压温度特性 Breakdown Voltage Temperature Coefficient	ΔBV _{DSS} /Δ T _J	I _D =250μA, referenced to 25℃	-	0.05	-	V/℃
零栅压下漏极漏电流 Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =55V, V _{GS} =0V, T _C =25℃	-	-	1	μA
		V _{DS} =44V, T _C =125℃	-	-	100	μA
栅极体漏电流 Gate-body leakage current	I _{GSS} (F/R)	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
通态特性 On-Characteristics						
阈值电压 Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =250μA	2.5	-	4.5	V
静态导通电阻 Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =10V , I _D =62A	-	7.6	8.5	mΩ
正向跨导 Forward Transconductance	g _{fs}	V _{DS} = 10V, I _D =62A (note 4)	-	18	-	S
动态特性 Dynamic Characteristics						
栅电阻 Gate Resistance	R _g	f=1.0MHz, V _{DS} OPEN	-	4.6	-	Ω
输入电容 Input capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1.0MHz	-	2365	-	pF
输出电容 Output capacitance	C _{oss}		-	740	-	
反向传输电容 Reverse transfer capacitance	C _{rss}		-	168	-	
开关特性 Switching Characteristics						
延迟时间 Turn-On delay time	t _{d(on)}	V _{DD} =28V, I _D =62A, R _G =20Ω V _{GS} =10V (note 4, 5)	-	19.9	-	ns
上升时间 Turn-On rise time	t _r		-	83	-	ns
延迟时间 Turn-Off delay time	t _{d(off)}		-	58	-	ns
下降时间 Turn-Off Fall time	t _f		-	42	-	ns
栅极电荷总量 Total Gate Charge	Q _g	V _{DS} =44V , I _D =62A , V _{GS} =10V (note 4, 5)	-	67	-	nC
栅－源电荷 Gate-Source charge	Q _{gs}		-	13	-	nC
栅－漏电荷 Gate-Drain charge	Q _{gd}		-	35	-	nC
漏－源二极管特性及最大额定值 Drain-Source Diode Characteristics and Maximum Ratings						
正向最大连续电流 Maximum Continuous Drain -Source Diode Forward Current	I _S		-	-	110	A
正向最大脉冲电流 Maximum Pulsed Drain-Source Diode Forward Current	I _{SM}		-	-	440	A
正向压降 Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =62A	-	-	1.2	V
反向恢复时间 Reverse recovery time	t _{rr}	V _{GS} =0V, I _S =162A ,dI _F /dt=100A/μs (note 4)	-	67	-	ns
反向恢复电荷 Reverse recovery charge	Q _{rr}		-	0.17	-	μC

热特性 THERMAL CHARACTERISTIC

项目 Parameter	符号 Symbol	最大值 Max	单位 Unit
结到管壳的热阻 Thermal Resistance, Junction to Case	Rth(j-c)	0.62	℃/W
结到环境的热阻 Thermal Resistance, Junction to Ambient	Rth(j-A)	62.5	℃/W

注释：
1：脉冲宽度由最高结温限制
2：L=1mH, IAS=25A, VDD=50V, RG=25 Ω,起始结温 TJ=25℃
3：ISD ≤110A,di/dt ≤300A/μs,VDD≤BVDSS,起始结温 TJ=25℃
4：脉冲测试：脉冲宽度 ≤300μs,占空比≤2％
5：基本与工作温度无关

Notes:
1: Pulse width limited by maximum junction temperature
2: L=1mH, IAS=25A, VDD=50V, RG=25 Ω,Starting TJ=25℃
3: ISD ≤110A,di/dt ≤300A/μs,VDD≤BVDSS, Starting TJ=25℃
4: Pulse Test: Pulse Width ≤300μs,Duty Cycle≤2％
5: Essentially independent of operating temperature

Typical Performance Characteristics

图1. 输出特性(25°C)

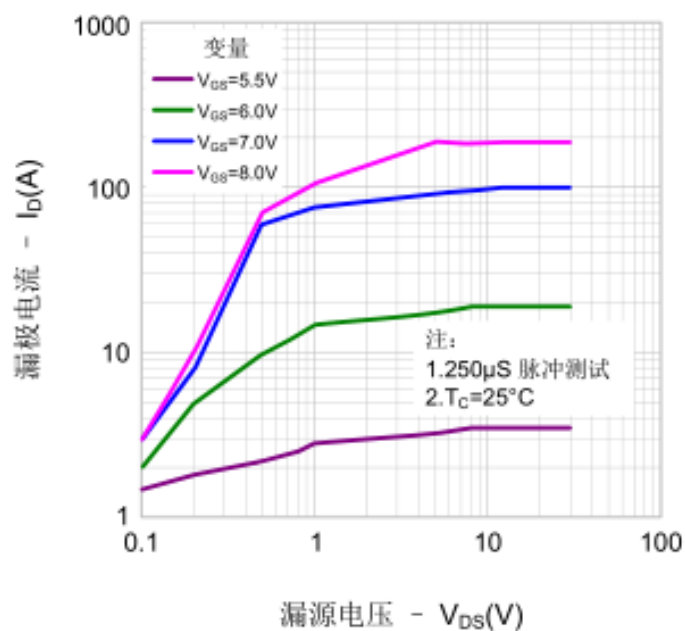


图2. 输出特性(175°C)

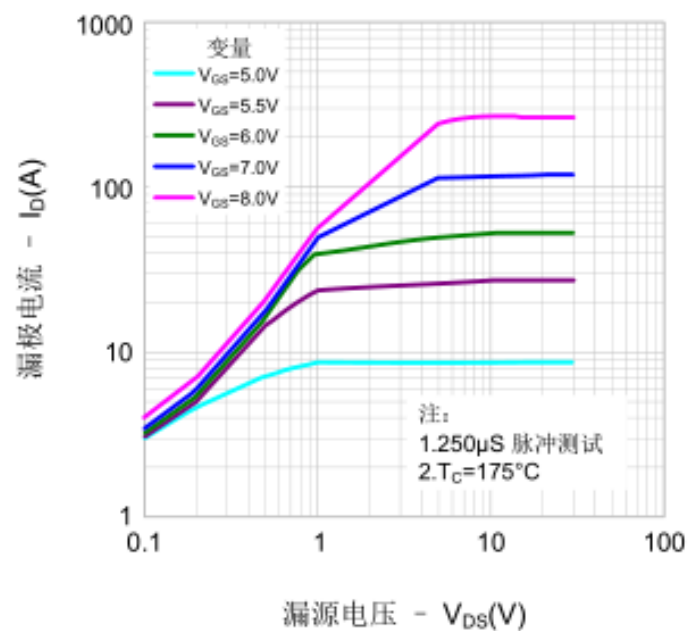


图3. 传输特性

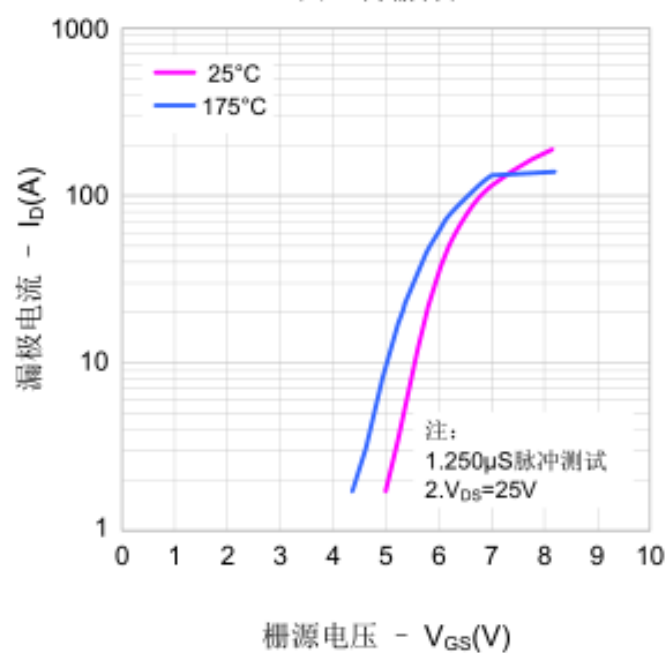


图4. 源漏二极管正向压降

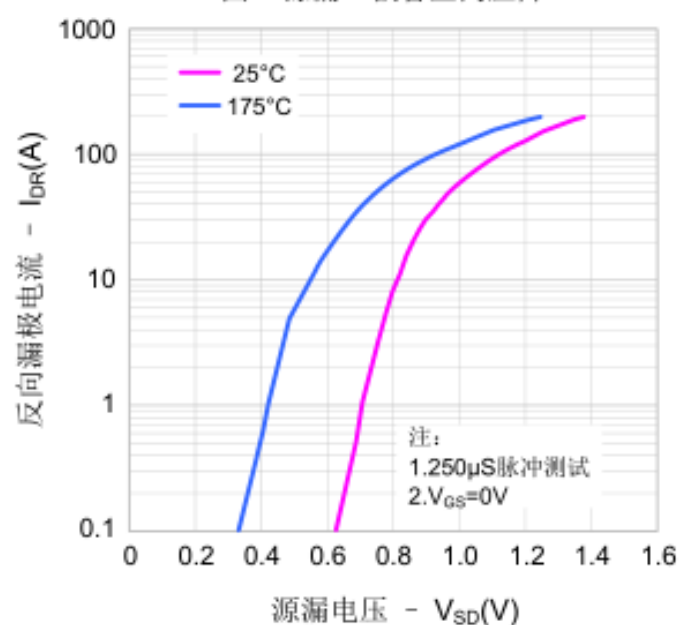


图5. 电容特性

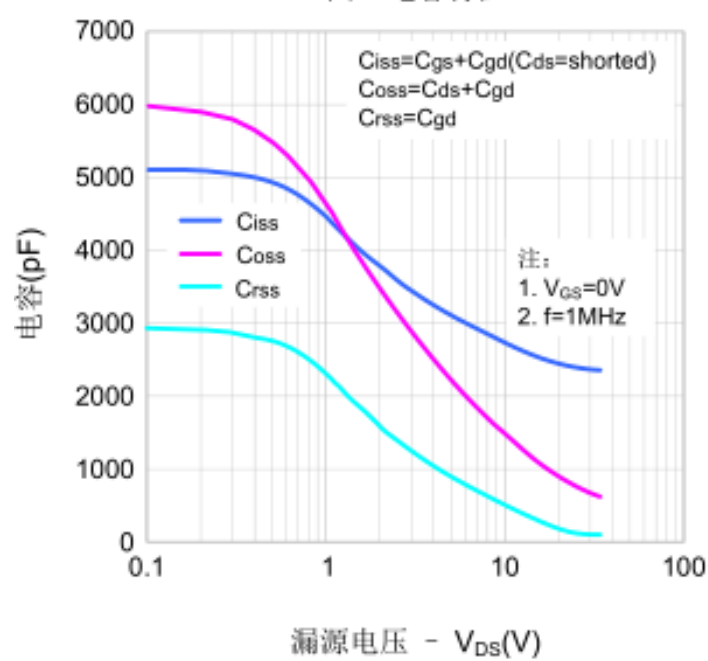
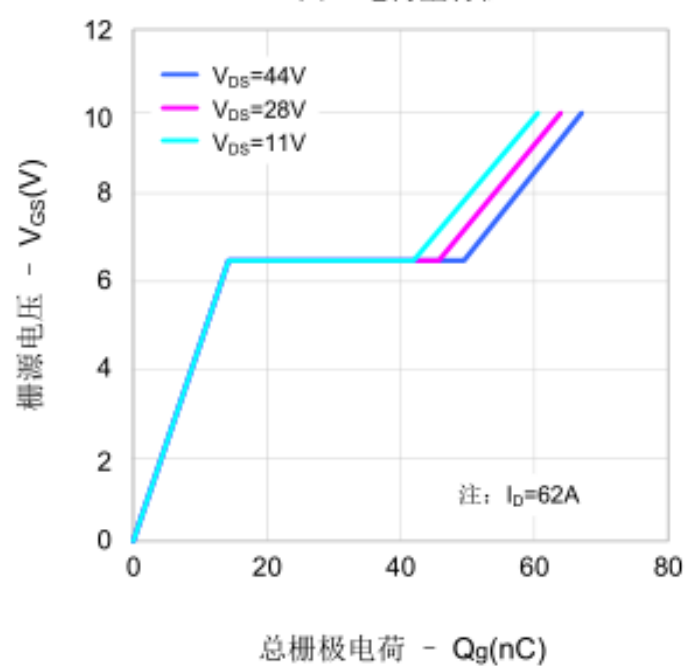
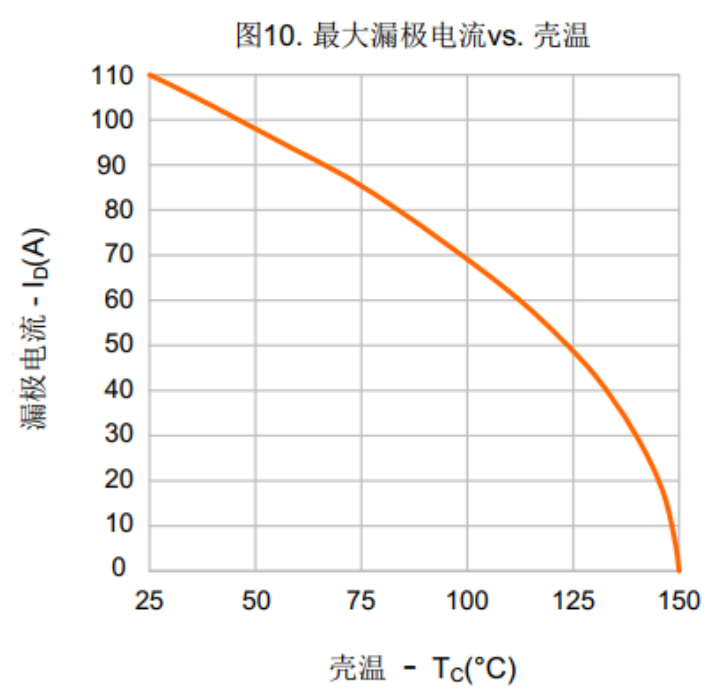
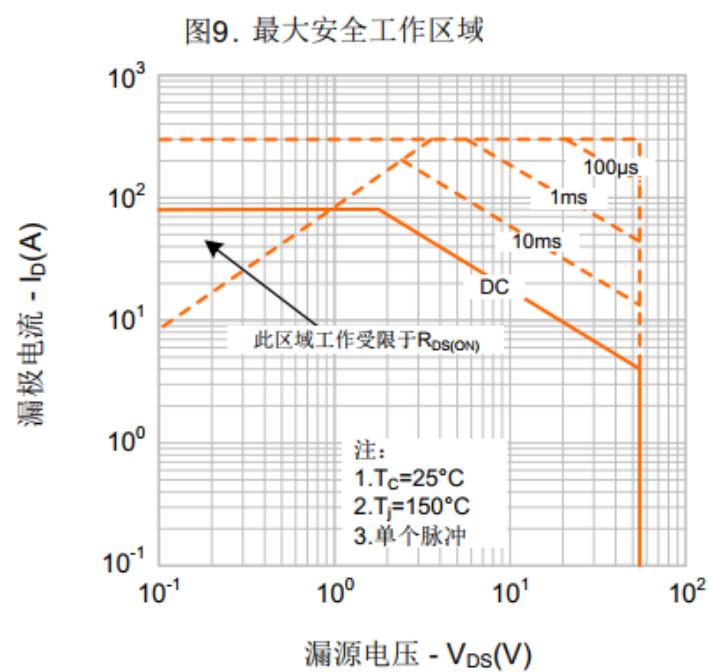
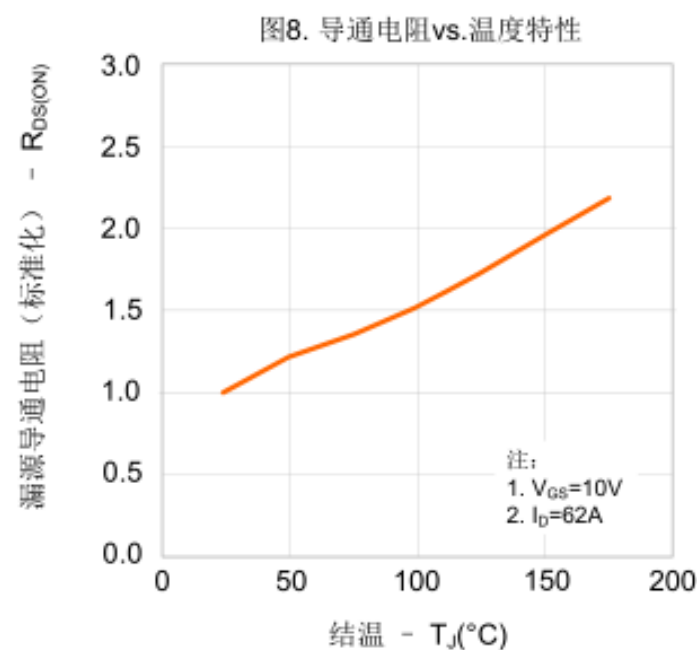
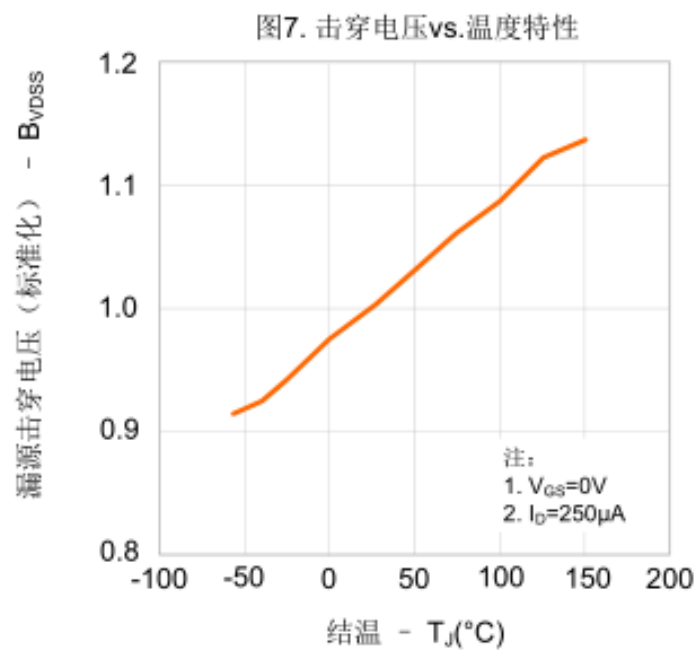


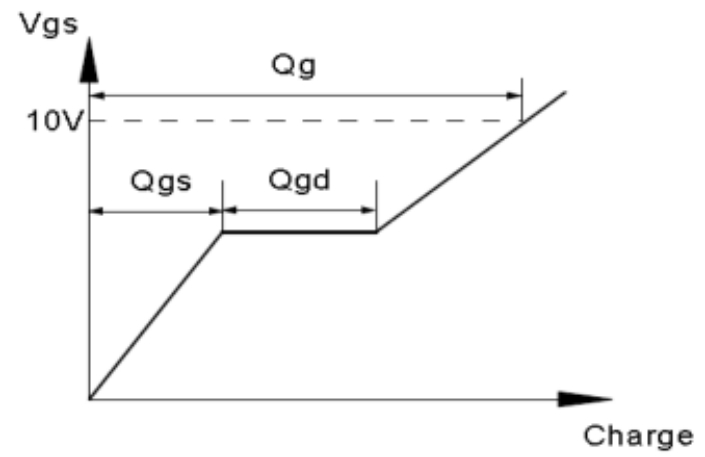
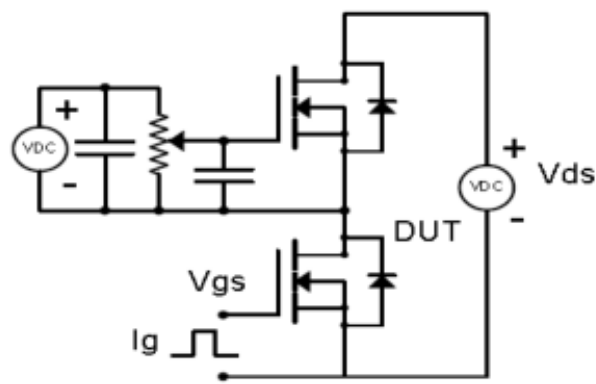
图6. 电荷量特性



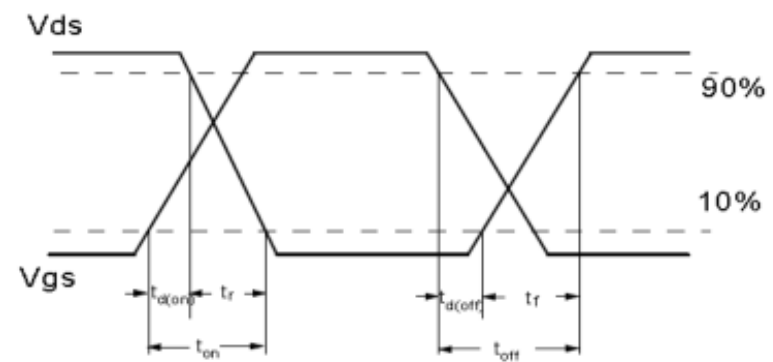
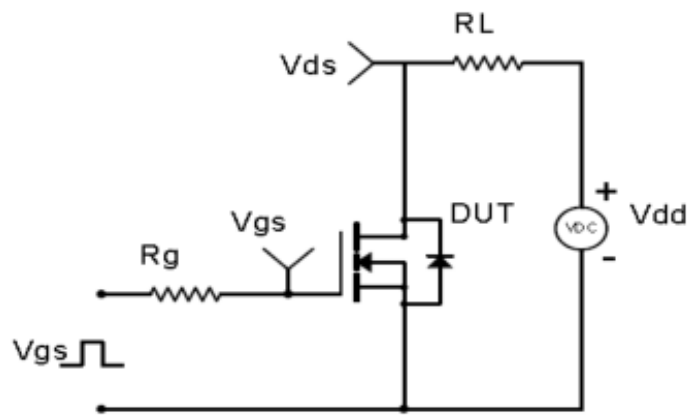


Test Circuit & Waveform

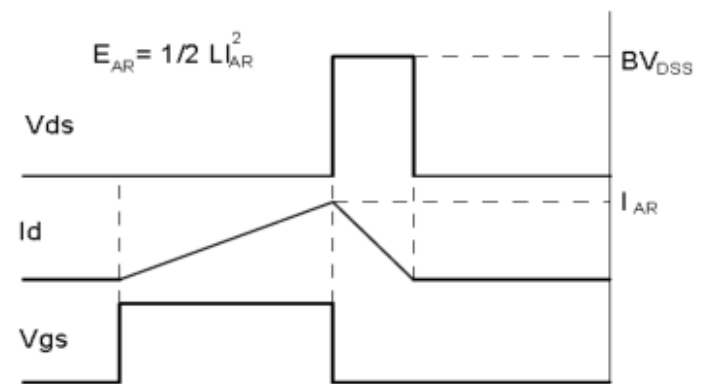
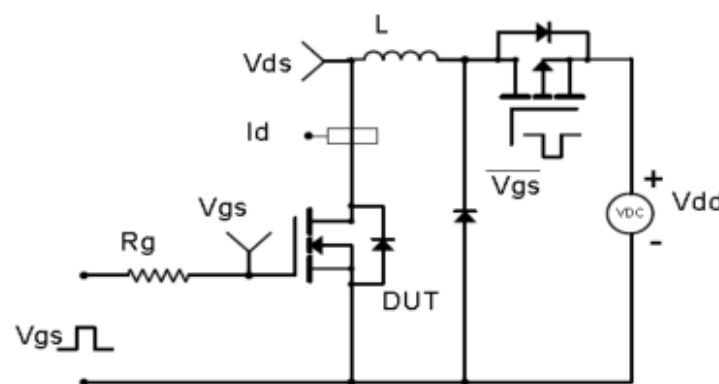
Gate Charge Test Circuit & Waveform



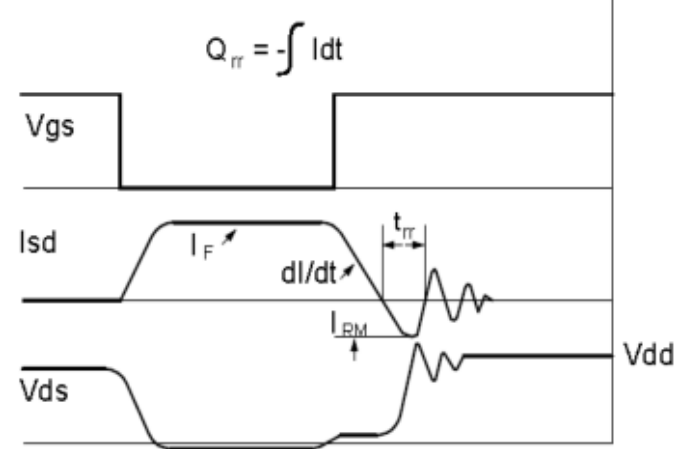
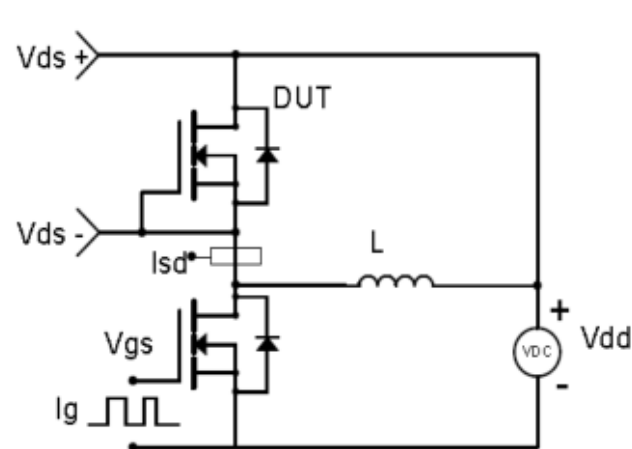
Resistive Switching Test Circuit & Waveforms



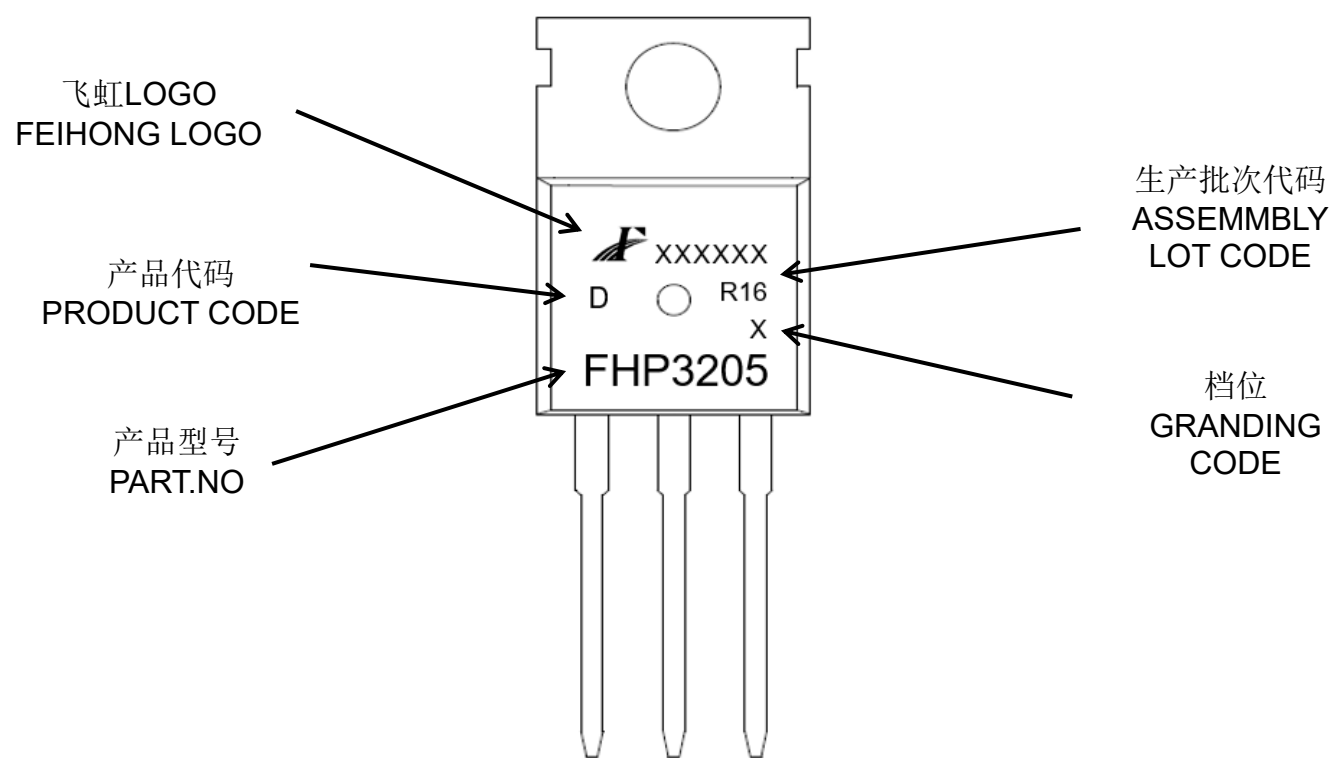
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



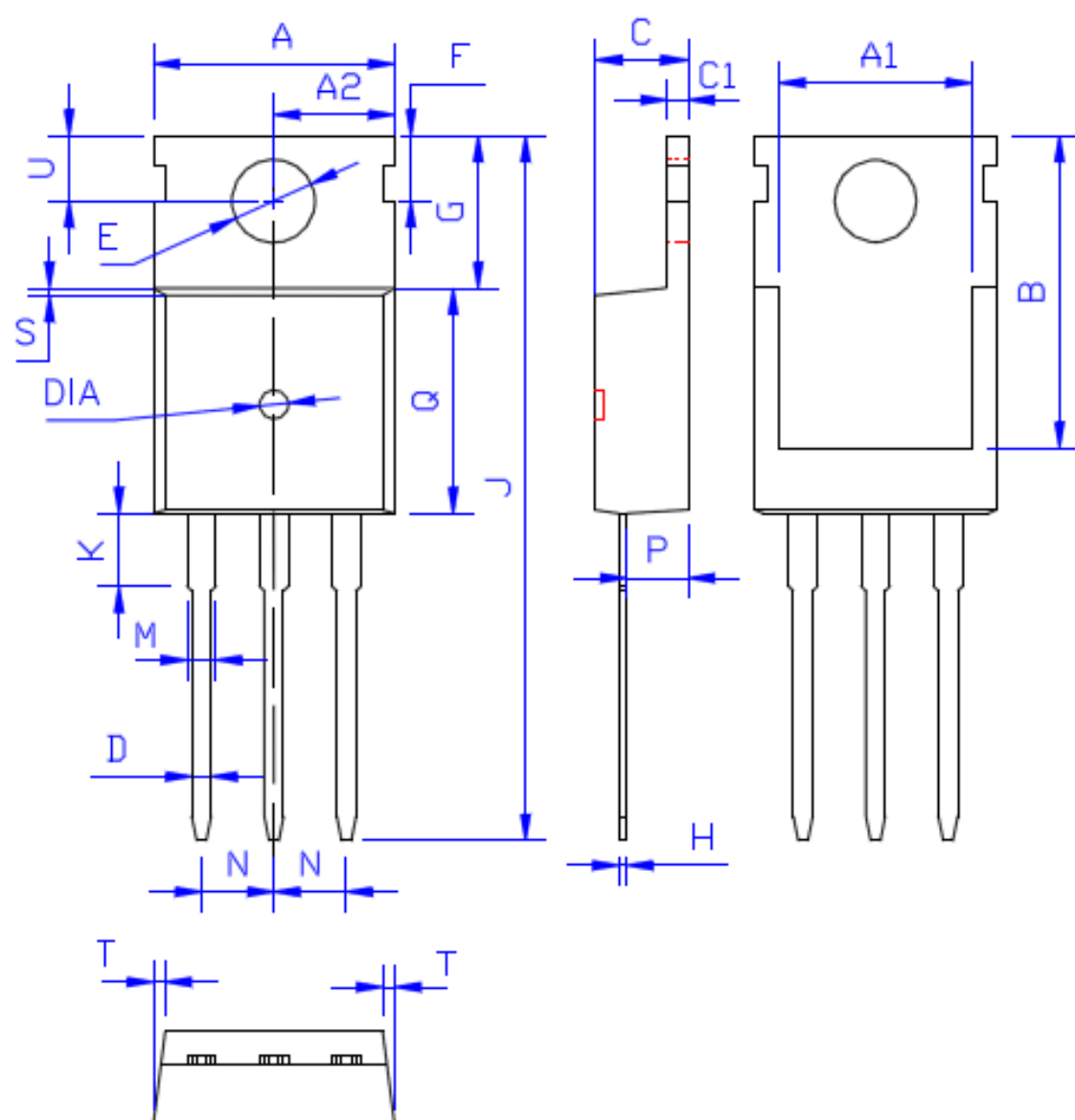
印记 Marking:



外形尺寸:

Package Dimension:

TO-220



DIM	MILLIMETERS
A	10.00±0.30
A1	8.00±0.30
A2	5.00±0.30
B	13.20±0.40
C	4.50±0.20
C1	1.30±0.20
D	0.80±0.20
E	3.60±0.20
F	3.00±0.30
G	6.60±0.40
H	0.50±0.20
J	28.88±0.50
K	3.00±0.30
M	1.30±0.30
N	Typical 2.54
P	2.40±0.40
Q	9.20±0.40
S	0.25±0.15
T	0.25±0.15
U	2.80±0.30
DIA	宽 1.50±0.10 深 0.50 MAX

(Unit: mm)